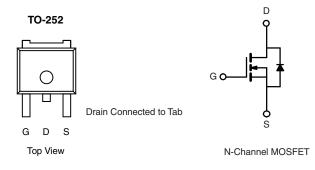
# SQD25N06-22L



Vishay Siliconix

# Automotive N-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.022			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.033			
I <sub>D</sub> (A)	25			
Configuration	Single			



#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Package with Low Thermal Resistance
- 100 %  $\rm R_g$  and UIS Tested
- AEC-Q101 Qualified<sup>d</sup>
- Compliant to RoHS Directive 2002/95/EC



ORDERING INFORMATION	
Package	TO-252
Lead (Pb)-free and Halogen-free	SQD25N06-22L-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	60	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
Continuous Drain Current	T <sub>C</sub> = 25 °C <sup>a</sup>	I_	25		
Continuous Drain Current	T <sub>C</sub> = 125 °C	l I <sub>D</sub>	20		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	25	А	
Pulsed Drain Currentb		I <sub>DM</sub>	100		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	24		
Single Pulse Avalanche Energy		E <sub>AS</sub>	28	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	PD	62	w	
Maximum Fower Dissipation	T <sub>C</sub> = 125 °C	гЪ	20	٧٧	
Operating Junction and Storage Temperature Range	)	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W	
Junction-to-Case (Drain)		R <sub>thJC</sub>	2.4	0/10	

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

c. When mounted on 1" square PCB (Fr-4 material).

d. Parametric verification ongoing.

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<b>SPECIFICATIONS</b> ( $T_C = 25 \ ^{\circ}C_{,}$	, unless otherv	vise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•	•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	$V_{GS} = 0 V, I_D = 250 \mu A$		-	-	v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		2.0	2.5		
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1.0		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	25	-	-	Α	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A	-	0.018	0.022	Ω	
Drain-Source On-State Resistance <sup>a</sup>	В	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.039		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.049		
		$V_{GS} = 4.5 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 25 °C	-	0.027	0.033		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 12 A	-	32	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>		/ V <sub>DS</sub> = 25 V, f = 1 MHz	-	1580	1975	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	305	382		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	130	163		
Total Gate Charge <sup>c</sup>	Qg			-	33	50		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 25 \text{ A}$	-	5.3	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	6.8	-		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.1	2.2	3.3	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	8	12		
Rise Time <sup>c</sup>	t <sub>r</sub>	$\begin{array}{l} V_{\text{DD}} = 30 \text{ V}, \ R_{\text{L}} = 1.2 \ \Omega \\ I_{\text{D}} \cong 25 \text{ A}, \ V_{\text{GEN}} = 10 \text{ V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$		-	10	15	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	24	36		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	6	9		
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>					•		
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	100	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =	25 A, V <sub>GS</sub> = 0 V	-	0.9	1.5	V	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

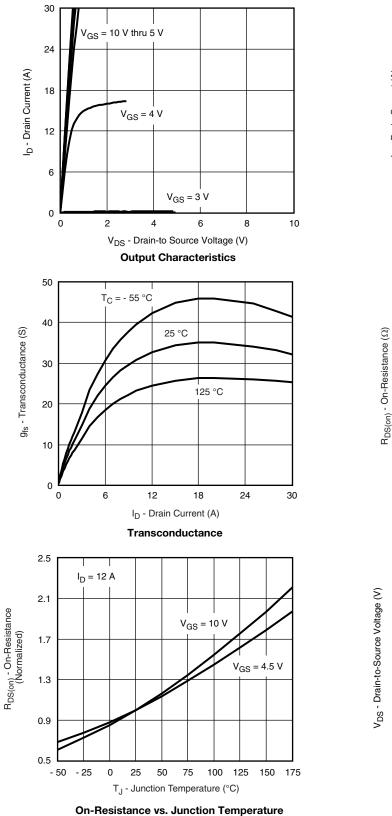
2

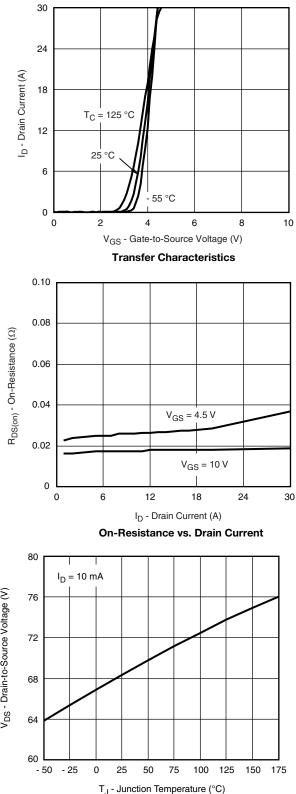
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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)





Drain Source Breakdown vs. Junction Temperature

S11-2046-Rev. C, 24-Oct-11

Document Number: 65360

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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

100 0.25 T<sub>J</sub> = 150 °C 10 0.20 R<sub>DS(on)</sub> - On-Resistance I<sub>S</sub> - Source Current (A) T<sub>J</sub> = 25 °C 0.15 1 0.10 0.1  $T_J = 150 \ ^{\circ}C$ 0.05 0.01  $T_J = 25 \ ^{\circ}C$ 0.001 0 0 0.2 0.4 0.6 0.8 1.0 1.2 0 2 4 6 8 10 V<sub>GS</sub> - Gate-to-Source Voltage (V) V<sub>SD</sub> - Source-to-Drain Voltage (V) Source Drain Diode Forward Voltage **On-Resistance vs. Gate-to-Source Voltage** 3000 10 I<sub>D</sub> = 25 A 2500 V<sub>GS</sub> - Gate-to-Source Voltage (V) 8 C - Capacitance (pF)  $V_{DS} = 30 V$ 2000 Ciss 6 1500 4 1000 Coss 2 500 C<sub>rss</sub> 0 0 5 10 15 25 35 0 20 30 10 30 40 50 60 0 20 V<sub>DS</sub> - Drain-to-Source Voltage (V) Q<sub>q</sub> - Total Gate Charge (nC) Capacitance **Gate Charge** 0.6 0.3 V<sub>GS(th)</sub> - Variance (V) 0 - 0.3  $I_D = 5 \text{ mA}$ - 0.6 I<sub>D</sub> = 250 μA - 0.9 - 1.2 - 50 - 25 0 25 50 75 100 125 150 175 T<sub>J</sub> - Temperature (°C) **Threshold Voltage** 



# SQD25N06-22L

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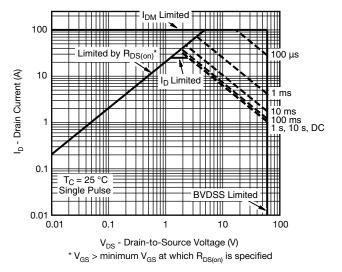
Document Number: 65360



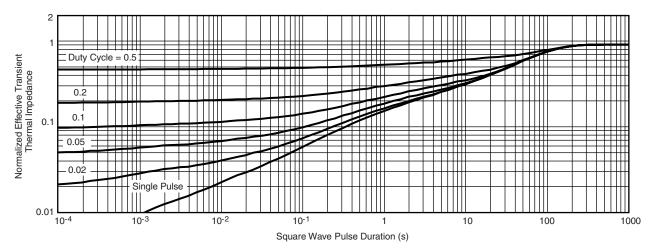
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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Safe Operating Area

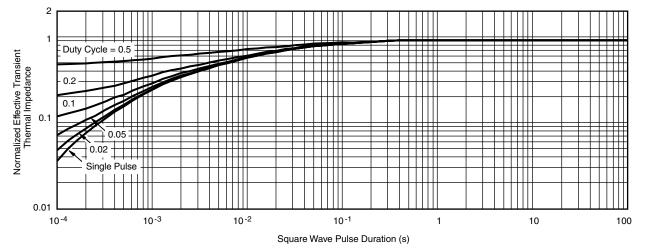


Normalized Thermal Transient Impedance, Junction-to-Ambient



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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

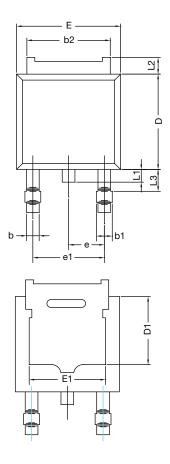
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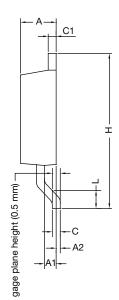


# Package Information

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### **TO-252AA CASE OUTLINE**





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
A2	0.030	0.127	0.001	0.005	
b	0.71	0.88	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.44	0.206	0.214	
С	0.46	0.58	0.018	0.023	
C1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
D1	4.10	4.45	0.161	0.175	
E	6.48	6.73	0.255	0.265	
E1	4.49	5.50	0.177	0.217	
е	2.28	BSC	0.090 BSC		
e1	4.57	BSC	0.180 BSC		
Н	9.65	10.41	0.380	0.410	
L	1.40	1.78	0.055	0.070	
L1	0.64	1.02	0.025	0.040	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.040	0.060	
ECN: T11- DWG: 534	0110-Rev. L, <sup>-</sup> 7	18-Apr-11			

Note

• Dimension L3 is for reference only.

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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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